

PRODUCT DATASHEET



- ► PTH Lamp
- ➤ 3mm Cylindrical 3.8t
- ➤ Warm White (3400K)

NOW16L96ZR (Bulk) NOW16L96ZRT (Taping)



3mm Cylindrical Lamp





FEATURES:

• Package: PTH Lamp 3mm Cylindrical 3.8t

Forward Current: 20mAForward Voltage (typ.): 3.2V

• Luminous Intensity (typ.): 500mcd @20mA

• Colour: Warm White

Colour Temperature: 2800-4400K

Viewing angle: 150°

• Electrostatics Discharge (ESD): 200V

Materials:

Die: InGaN

Resin: Epoxy (Water Clear)

• Operating Temperature: -40~+85°C

• Storage Temperature: -40~+100°C

Grouping parameters:

Forward voltage

Luminous intensity

CIE Chromaticity

• Soldering methods: Hand; Wave Soldering (DIP)

Preconditioning: acc. to JEDEC Level 3

Packing: 500pcs/Bulk; 2000pcs/Taping

3 mm Cylindrical Lamp

APPLICATIONS:

- Indicator
- Switch
- Signal Light



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	30	mA
Peak Forward Current Duty 1/10@1KHz	I _{FP}	100	mA
Reverse Current @5V	I _R	10	μΑ
Power Dissipation	P _D	85	mW
Electrostatics Discharge	ESD	2000	V
Operating Temperature	T_OPR	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Cumbal	Values			Unit	Test	
Parameter	Symbol	Min.	Typ. Max.		Onit	Condition	
Forward Voltage	V_{F}	2.9	3.2	3.5	V	I _F =20mA	
Luminous Intensity	I _V	310	500	1000	mcd	I _F =20mA	
Chromaticity Coordinates	Х		0.4200			I _F =20mA	
	Υ		0.4200				
Colour Temperature	ССТ	2800	3400	4400	К	I _F =20mA	
Viewing Angle	2θ _{1/2}		150		deg	I _F =20mA	

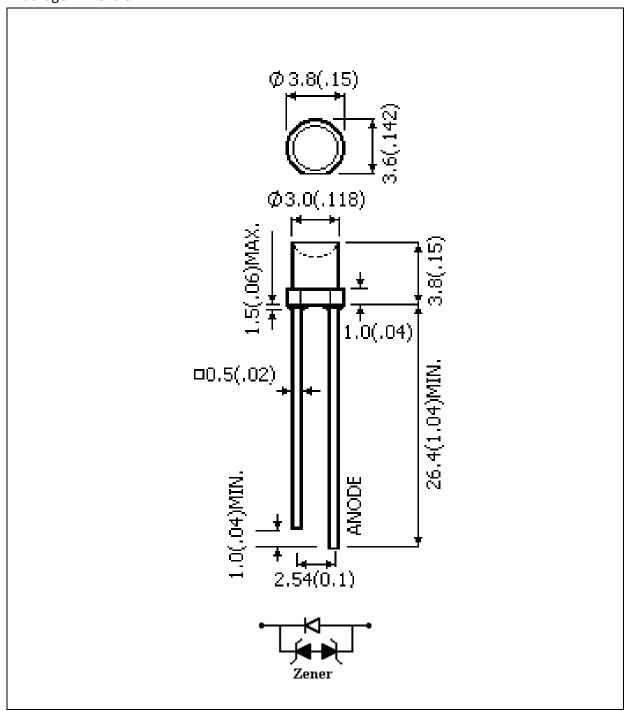
^{1.} Luminous intensity (I_V) ±15%, Forward Voltage (V_F) ±0.1V

2.



OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.25mm, unless otherwise noted.



BINNING GROUPS:

Forward Voltage Classifications ($I_F = 20mA$):

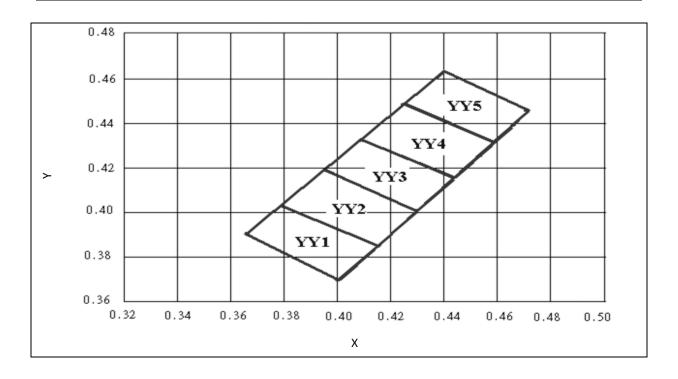
Code	Min.	Max.	Unit
J	2.8	3.0	
К	3.0	3.2	V
L	3.2	3.4	V
M	3.4	3.6	

Luminous Intensity Classifications ($I_F = 20 \text{mA}$):

Code	Min.	Max.	Unit
13	310	460	
14	460	690	mcd
15	690	1000	



CIE CHROMATICITY DIAGRAM:

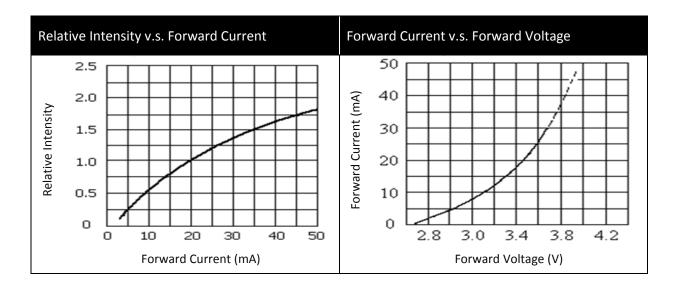


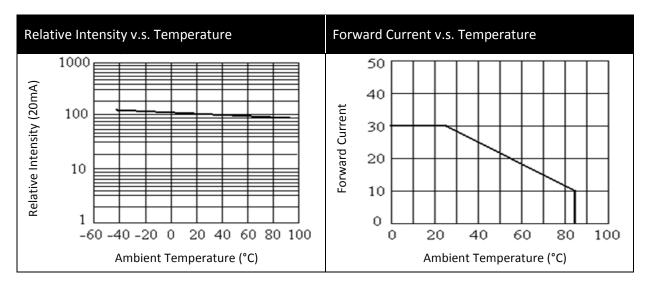
Chromaticity Coordinates Classifications ($I_F = 20$ mA):

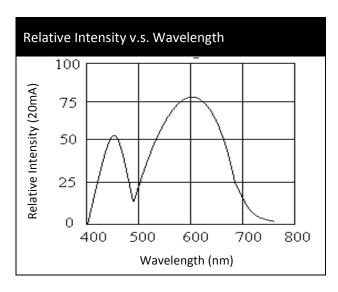
	1	1	2	2		3		4	
	Х	Υ	Х	Υ	Х	Υ	Х	Υ	
YY1	0.3650	0.3900	0.3800	0.4050	0.4180	0.3850	0.4000	0.3700	
YY2	0.3800	0.4050	0.3950	0.4200	0.4310	0.4010	0.4180	0.3850	
YY3	0.3950	0.4200	0.4100	0.4350	0.4440	0.4160	0.4310	0.4010	
YY4	0.4100	0.4350	0.4250	0.4500	0.4600	0.4300	0.4440	0.4160	
YY5	0.4250	0.4500	0.4400	0.4650	0.4730	0.4460	0.4600	0.4300	



ELECTRO-OPTICAL CHARACTERISTICS:







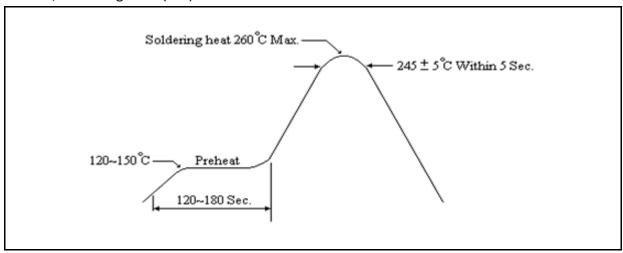


RECOMMENDED SOLDERING PROFILE:

Hand Solder (Solder Iron):

- Temperature at tip of iron: 300°C Max. (25W Max.).
- Soldering Time: 3 seconds ± 1 sec.
- Maximum reflow soldering: 1 time.

Wave / Soldering Heat (DIP):



Note:

- 1. Maximum reflow soldering: 1 time.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension: 500pcs/Bulk CAUTION ELECTROSTATIC SENSITIVE DEVICES DO NOT OPEN OR HANDLE EXCEPT AT A STATIC-FREE WORKSTATION 2000pcs/Taping



PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

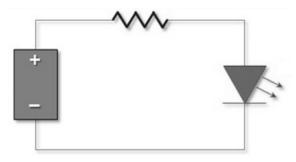
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	04/08/2015	Datasheet set-up.
A1.1	21/09/2015	Update solder profile.
A1.2	23/10/2015	Revise diode drawing direction.